International IR Rectifier

AUTOMOTIVE GRADE

AUIRLR3410

HEXFET® Power MOSFET

Advanced Planar Technology

- Low On-Resistance
- Dynamic dV/dT Rating
- 175°C Operating Temperature
- Fast Switching

Features

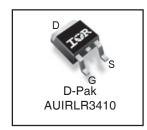
- Fully Avalanche Rated
- Repetitive Avalanche Allowed up to Tjmax
- Lead-Free, RoHS Compliant
- Automotive Qualified *

Description

Specifically designed for Automotive applications, this Stripe Planar design of HEXFET® Power MOSFETs utilizes the latest processing techniques to achieve low on-resistance per silicon area. This benefit combined with the fast switching speed and ruggedized device design that HEXFET power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in Automotive and a wide variety of other applications.



V _{(BR)DSS}	100V
R _{DS(on)} max.	105m $Ω$
I _D	17A



G	D	S
Gate	Drain	Source

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V	17	
I _D @ T _C = 100°C	Continuous Drain Current, V _{GS} @ 10V	12	Α
I _{DM}	Pulsed Drain Current ①	60	
	Power Dissipation	79	W
	Linear Derating Factor	0.53	W/°C
V_{GS}	Gate-to-Source Voltage	± 16	V
E _{AS}	Single Pulse Avalanche Energy (Thermally Limited) ②⑤	150	mJ
I _{AR}	Avalanche Current ①⑤	9.0	А
E _{AR}	Repetitive Avalanche Energy ①⑤	7.9	mJ
dv/dt	Peak Diode Recovery ③	5.0	V/ns
T_J	Operating Junction and	-55 to + 175	
T _{STG}	Storage Temperature Range		°C
	Soldering Temperature, for 10 seconds (1.6mm from case)	300	

Thermal Resistance

	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case ®		1.9	
$R_{\theta JA}$	Junction-to-Ambient (PCB mount) ⑦		50	°C/W
$R_{\theta JA}$	Junction-to-Ambient		110	

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^{*}Qualification standards can be found at http://www.irf.com/

Static Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	100			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.122		V/°C	Reference to 25°C, I _D = 1mA
				0.105	Ω	V _{GS} = 10V, I _D = 10A ④
R _{DS(on)}	Static Drain-to-Source On-Resistance			0.125		$V_{GS} = 5.0V, I_D = 10A $ ④
				0.155		$V_{GS} = 4.0V, I_D = 9.0A$ ④
V _{GS(th)}	Gate Threshold Voltage	1.0		2.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
gfs	Forward Transconductance	7.7			S	$V_{DS} = 25V, I_D = 9.0A$ §
I _{DSS}	Drain-to-Source Leakage Current			25	μΑ	$V_{DS} = 100V, V_{GS} = 0V$
				250		$V_{DS} = 80V, V_{GS} = 0V, T_{J} = 150^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			100	nA	V _{GS} = 16V
	Gate-to-Source Reverse Leakage			-100		V _{GS} = -16V

Dynamic Electrical Characteristics @ T₁ = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
Q_g	Total Gate Charge			34		$I_D = 9.0A$
Q_{gs}	Gate-to-Source Charge			4.8	nC	$V_{DS} = 80V$
Q_{gd}	Gate-to-Drain ("Miller") Charge		_	20	Ī	V _{GS} = 5.0V @⑤
t _{d(on)}	Turn-On Delay Time		7.2			$V_{DD} = 50V$
t _r	Rise Time		53		Ī	$I_D = 9.0A$
t _{d(off)}	Turn-Off Delay Time		30		ns	$R_G = 6.0 \Omega$
t _f	Fall Time		26		Ī	V _{GS} = 5.0V ⊕⑤
L _D	Internal Drain Inductance		4.5			Between lead,
					nΗ	6mm (0.25in.)
L _S	Internal Source Inductance		7.5		Ī	from package
						and center of die contact
C _{iss}	Input Capacitance		800			$V_{GS} = 0V$
C _{oss}	Output Capacitance		160		Ī	$V_{DS} = 25V$
C _{rss}	Reverse Transfer Capacitance		90		pF	f = 1.0MHz ⑤

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions	
I _S	Continuous Source Current			17		MOSFET symbol	
	(Body Diode)				Α	showing the	
I _{SM}	Pulsed Source Current			60		integral reverse	
	(Body Diode) ①					p-n junction diode.	
V_{SD}	Diode Forward Voltage			1.3	V	$T_J = 25^{\circ}C$, $I_S = 9.0A$, $V_{GS} = 0V$ ④	
t _{rr}	Reverse Recovery Time		140	210		$T_J = 25^{\circ}C, I_F = 9.0A$	
Q _{rr}	Reverse Recovery Charge		740	1100	nC	di/dt = 100A/µs	
t _{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)					

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig.11)
- $\begin{tabular}{ll} \mathbb{O} $V_{DD}=25V, starting $T_J=25^\circ$C, $L=3.1mH$ \\ $R_G=25\Omega, I_{AS}=9.0A. (See Figure 12) \end{tabular}$
- $\label{eq:loss_def} \ \, \Im \ \, I_{SD} \leq 9.0A, \, di/dt \leq 540A/\mu s, \, V_{DD} \leq V_{(BR)DSS}, \, T_J \leq 175^{\circ}C$
- 4 Pulse width \leq 300µs; duty cycle \leq 2%.
- ⑤ Uses IRL530N data and test conditions.

- $\ensuremath{\mathfrak{G}}$ This is applied for L_S of D-PAK is measured between lead and center of die contact
- When mounted on 1" square PCB (FR-4 or G-10 Material). For recommended footprint and soldering techniques refer to application note #AN-994.
- ® R_θ is measured at Tj approximately 90°C.

Qualification Information[†]

		Automotive			
		(per AEC-Q101) ††			
Qualification	on Level	Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.			
Moisture Sensitivity Level		D-PAK MSL1			
	Machine Model	Class M4			
		AEC-Q101-002			
	Human Body Model	Class H1C			
ESD			AEC-Q101-001		
	Charged Device	Class C5			
	Model	AEC-Q101-005			
RoHS Com	npliant	Yes			

[†] Qualification standards can be found at International Rectifier's web site: http://www.irf.com/

^{††} Exceptions to AEC-Q101 requirements are noted in the qualification report.

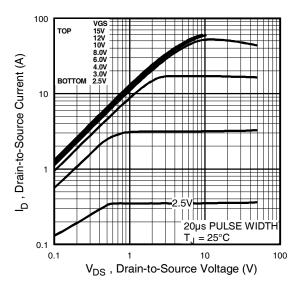


Fig 1. Typical Output Characteristics

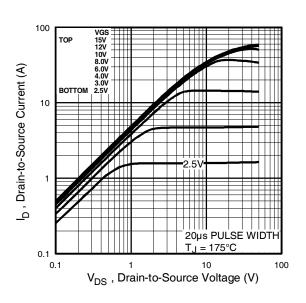


Fig 2. Typical Output Characteristics

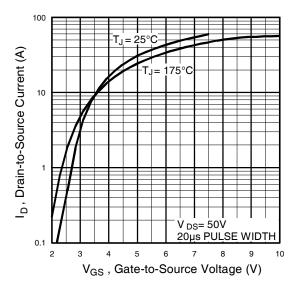


Fig 3. Typical Transfer Characteristics

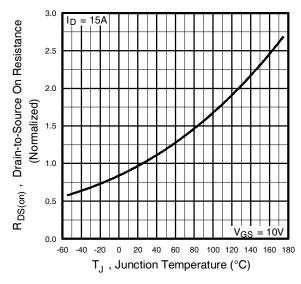


Fig 4. Normalized On-Resistance Vs. Temperature

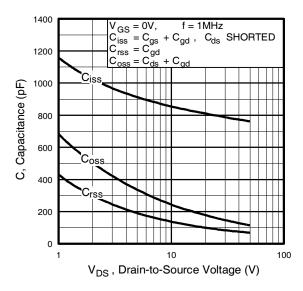


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

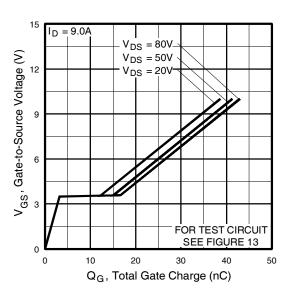


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

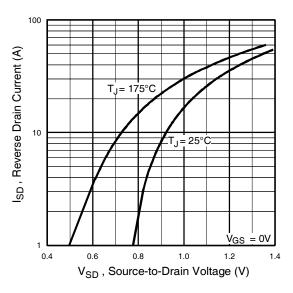


Fig 7. Typical Source-Drain Diode Forward Voltage

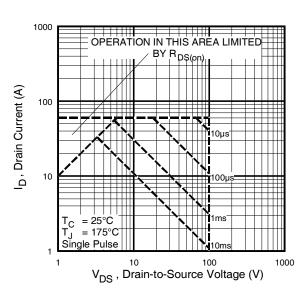


Fig 8. Maximum Safe Operating Area

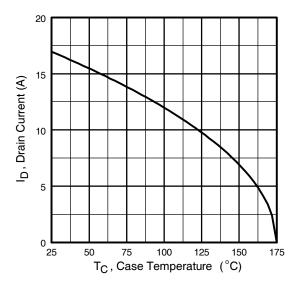


Fig 9. Maximum Drain Current Vs. Case Temperature

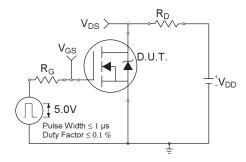


Fig 10a. Switching Time Test Circuit

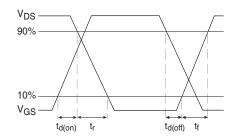


Fig 10b. Switching Time Waveforms

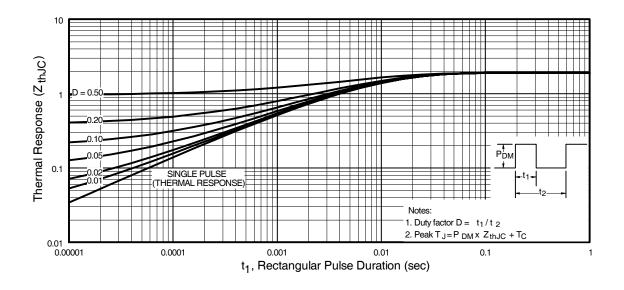


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

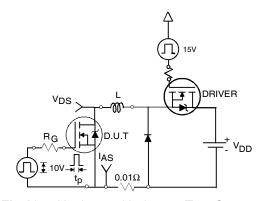


Fig 12a. Unclamped Inductive Test Circuit

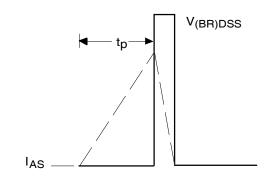


Fig 12b. Unclamped Inductive Waveforms

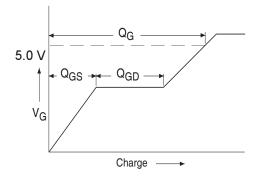


Fig 13a. Basic Gate Charge Waveform

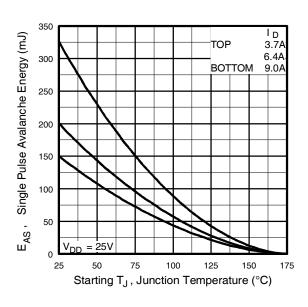


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

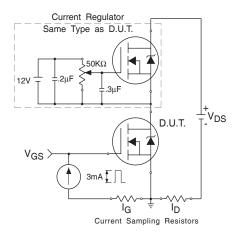
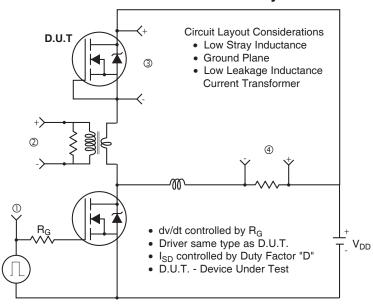


Fig 13b. Gate Charge Test Circuit

Peak Diode Recovery dv/dt Test Circuit



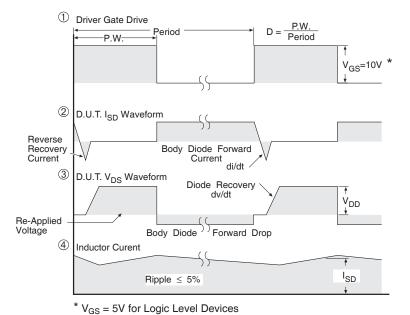


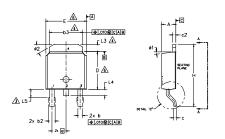
Fig 14. For N-Channel HEXFETS

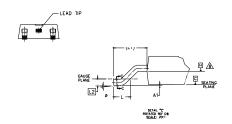
International IOR Rectifier

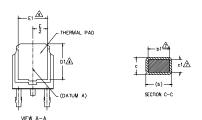
AUIRLR3410

D-Pak (TO-252AA) Package Outline

Dimensions are shown in millimeters (inches)







- 2.- DIMENSION ARE SHOWN IN INCHES [MILLIMETERS].
- A- LEAD DIMENSION UNCONTROLLED IN L5.

- ∆Sy. LEAD DIMENSION UNCONTROLLED IN L5.

 ADMENSION DI, EI, L3 & b3 ESTABLISH A MINIMUM MOUNTING SURFACE FOR THERMAL PAD.

 5.- SECTION C-C DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN .005 AND 0.10 [0.13 AND 0.25] FROM THE LEAD TIP.

 ADMENSION D & E DO NOT INCLUDE WOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005 [0.13] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.

 ADMENSION D & C I APPUED TO BASE METAL ONLY.

 ADDITUM A & B TO BE DETERMINED AT DATUM PLANE H.

 ADMINISTRATE CONSERVED A TO DESCRIPTION TO DES

_						
9	DUTLINE	CONFORMS	TO	JEDEC	OUTLINE	TO-252AA.

S Y M			N		
B O	MILLIM	ETERS	INC	HES	NOTES
0	MIN,	MAX.	MIN, MAX.		E S
Α	2.18	2.39	.086	.094	
A1	-	0.13	-	.005	
ь	0.64	0.89	.025	.035	
ы	0.65	0.79	.025	.031	7
b2	0.76	1.14	.030	.045	
b3	4.95	5,46	.195	.215	4
С	0.46	0,61	.018	.024	
c1	0,41	0.56	.016	.022	7
c2	0.46	0.89	.018	.035	
D	5.97	6.22	.235	.245	6
D1	5,21	- 1	.205	-	4
Ε	6.35	6.73	.250	.265	6
E1	4.32	-	.170	-	4
e	2.29	BSC	.090	BSC	
н	9.40	10.41	.370	.410	
L	1.40	1.78	.055	.070	
L1	2.74	BSC	.108	REF.	
L2	0,51	BSC	.020	BSC	
L3	0,89	1.27	.035	.050	4
L4	-	1.02	-	.040	
L5	1,14	1.52	.045	.060	3
ø	0.	10*	0.	10*	
ø1	0.	15"	0,	15*	
ø2	25*	35*	25*	35*	

LEAD ASSIGNMENTS

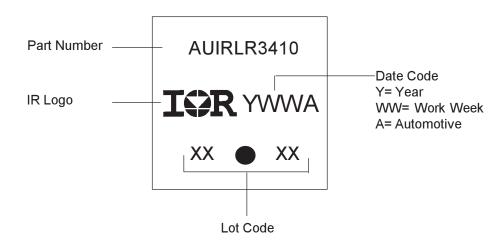
HEXFET

- 1.- GATE 2.- DRAIN 3.- SOURCE 4.- DRAIN

IGBT & CoPAK

- 1.- GATE 2.- COLLECTOR 3.- EMITTER 4.- COLLECTOR

D-Pak Part Marking Information

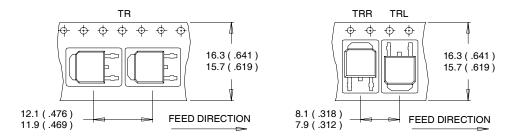


AUIRLR3410

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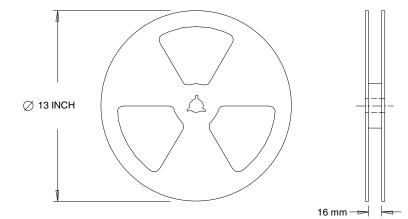
D-Pak (TO-252AA) Tape & Reel Information

Dimensions are shown in millimeters (inches)



NOTES:

- 1. CONTROLLING DIMENSION: MILLIMETER.
- 2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
- 3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES:

1. OUTLINE CONFORMS TO EIA-481.

Ordering Information

Base part	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRLR3410	Dpak	Tube	75	AUIRLR3410
		Tape and Reel	2000	AUIRLR3410TR
		Tape and Reel Left	3000	AUIRLR3410TRL
		Tape and Reel Right	3000	AUIRLR3410TRR

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For technical support, please contact IR's Technical Assistance Center

http://www.irf.com/technical-info/

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